



Product Specification

KSEGB19264-03 SERIES

Customer:		
Approved by:		
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Approved by	Checked by	Prepared by

RECORDS OF REVISION

Part Number	Revision	Revision Content	Revised on
KSEGB19264-03	00	First issue	Oct. 16th, 2013
KSEGB19264-03	01	Update Electronic-Optical Characteristics	May. 3rd, 2016
KSEGB19264-03	02	Update EXTERNAL DIMENSIONS	May. 17th, 2016

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1. FUNCTIONS & FEATURES

• KSEGB19264-03 SERIES TYPE:

Module Model	LCD Type	Remark
KSEGB19264-03	FSTN Positive Transflective Mode	Backlight: White

• Viewing Direction : 12 O'clock

• Driving Scheme : 1/64Duty, 1/9Bias

• Power Supply for logic : 5.0V

• Display Content : 192*64 Dots

 $\bullet V_{LCD} : 12.0V$

• Operation temperature : -20° C to $+70^{\circ}$ C • Storage temperature : -30° C to $+80^{\circ}$ C

2. MODULE ARTWORK

● Module Size : 120.00(L)*62.00 (W)*13.50(H)mm

• Viewing Area : 104.00(L)mm*39.00 (W)mm

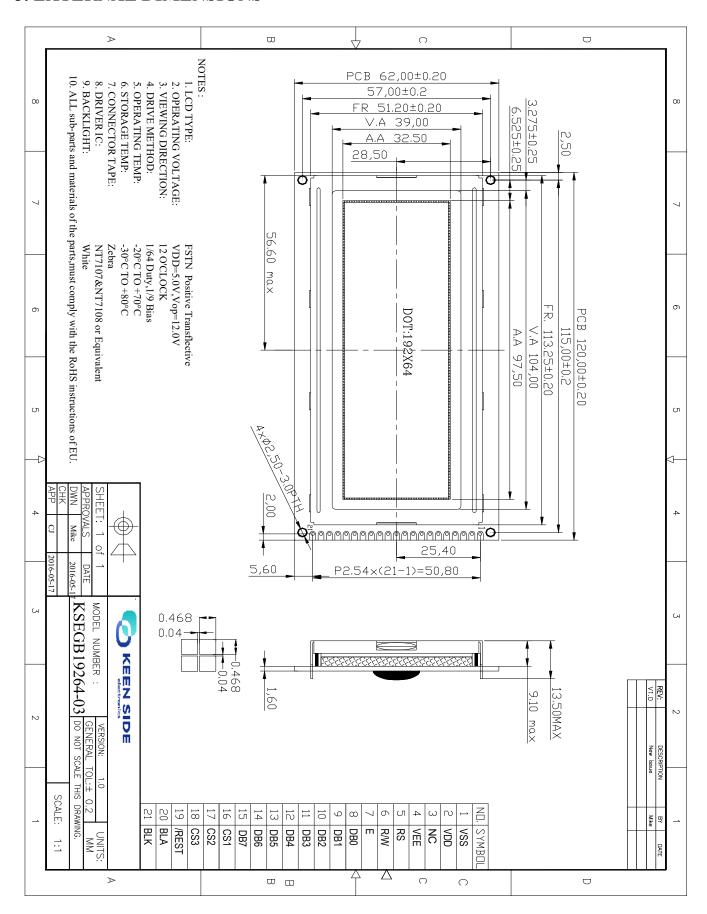
• Active Area : 97.50(L)mm*32.50(W)mm

• Dot Pitch : 0.508 (W)mm*0.508 (H)mm

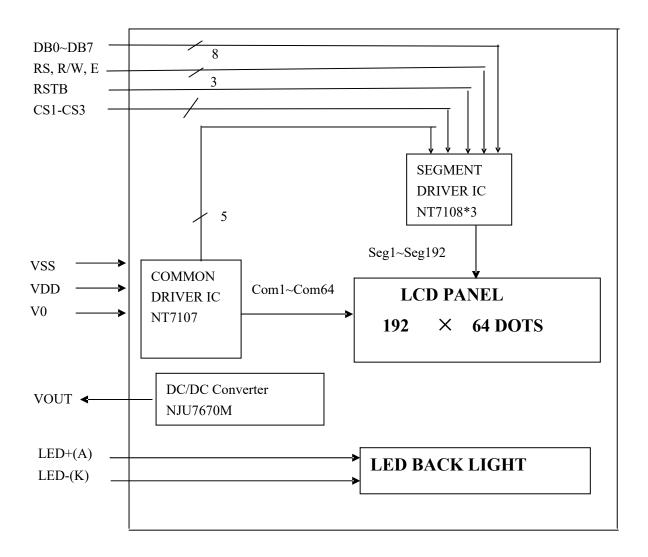
• Dot Size : 0.468 (W)mm*0.468 (H)mm

• Dot Gap : 0.04 mm

3. EXTERNAL DIMENSIONS



4. BLOCK DIAGRAM



5. PIN ASSIGNMENT

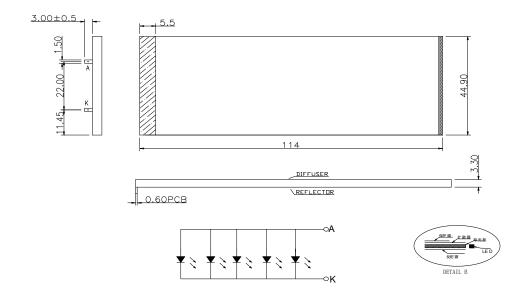
NO.	SYMBOL	FUNCTION
1	VSS	Ground (0V)
2	VDD	Power Supply(+5.0V)
3	NC	NO connector
4	VEE	Output voltage for LCD
5	/RS	Register select RS = 0···Instruction register $RS = 1$ ····Data register
6	R/W	Read /Write $R/W = 1 \cdots Read$ $R/W = 0 \cdots Write$
7	Е	Chip enable signal
8	DB0	Data input/output(LSB)
9	DB1	Data input/output
10	DB2	Data input/output
11	DB3	Data input/output
12	DB4	Data input/output
13	DB5	Data input/output
14	DB6	Data input/output
15	DB7	Data input/output(MSB)
16	/CS1	Chip selection In order to interface data for input or output; The terminals
17	/CS2	have to be CS1B=L, CS2B=L, and CS3=H
18	/CS3	have to be Coth-L, Cozh-L, and Cos-H
19	/RST	Controller reset when "L"
20	LED+(A)	Anode of LED backlight(+5.0V)
21	LED-(K)	Cathode of LED backlight

6. ABSOLUTE MAXIMUM RATINGS(Vss=0V, Ta=25C)

PARAMETER	SYMBOL	RATING	UNIT
Supply Voltage (Logic)	$V_{ m DD}$	-0.3 to 7.0	V
Input voltage	$ m V_{IN}$	-0.3 to VDD +0.3	V
Operating Temperature	Topr	-20 to +70	$^{\circ}\mathbb{C}$
Storage Temperature	Tstg	-30 to +80	$^{\circ}$

7. BACKLIGHT ELECTRICAL/OPTICAL CHARACTERISTICS

	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Forward Voltage	Vf	4.5	5.0	5.5	V	If=15*5 mA
Forward Current	l f		75		mΑ	
Power Dissipation	Pd	0.36			W	If=15*5 mA
Reverse Voltage	Vr		5.0		V	If=15*5 mA
Luminous Intensity	L _V		TBD		cd/m²	If=15*5 mA
Luminous Uniformity	Δ Lv	75			%	If=15*5 mA
Facinais Manalan ath	X	0.22		0.26		If=15mA Ta=25°
Emission Wavelength	Υ	0.22		0.26		Each chip



8. ELECTRICAL CHARACTERISTICS

1). DC Characteristics

Ta=25°C, VSS=0V

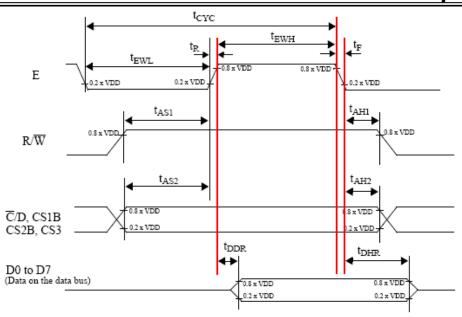
						,
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Supply Voltage (Logic)	V_{DD} - V_{SS}	-	4.5	5.0	5.5	V
High Level Input Voltage	$ m V_{IH}$	V _{DD} =5.0V±10%	V_{DD} -2.2	-	V_{DD}	V
Low Level Input Voltage	$ m V_{IL}$	V _{DD} =5.0V±10%	0	-	0.8	V
High Level Output Voltage	V_{OH}	$I_{OH}=0.75Ma$	V_{DD} -0.3	-	V_{DD}	V
Low Level Output Voltage	V_{OL}	$I_{OL}=0.75$ Ma	0	-	0.3	V
Current	$I_{DD(1)}$	$V_{DD}=5.0V$	-	5.0	10.0	mA
Consumption(Operating)		$f_{OSC} = 3.0 \text{ MHz}$				
LCD Drive Voltage	Vlcd		11.80	12.00	12.20	V

2). AC Characteristics

8-2-1. AC timing for writing to the NT7107

$$(VDD = 5 V; VSS = 0 V; Tamb = 25^{\circ} C.)$$

symbol	parameter	min.	max.	test conditions	unit
t _{CYC}	Enable (E) cycle time	1000			
t _{EWL}	Enable (E) LOW width	450			1
t _{EWH}	Enable (E) HIGH width	450			1
t _R	Enable (R) rise time		20		1
t _F	Enable (F) fall time		20		1
t _{AS1}	Write set-up time	140			ns
t _{AH1}	Write hold time	10			7
t _{AS2}	C/D, CS1B, CS2B, CS3 set-up time	140			7
t _{AH2}	C/D, CS1B, CS2B, CS3 hold time	10			
t _{DSW}	Data setup time (on the data bus)	200		The loading on	1
t _{DHW}	Data hold time (on the data bus)	10		the data bus is shown in Fig. 18.	

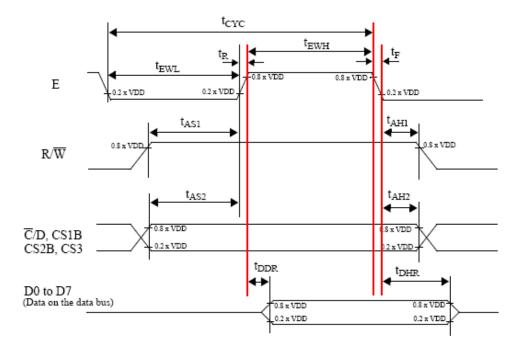


8-2-2. AC timing for reading from the NT7107

 $(VDD = 5 V; VSS = 0 V; Tamb = 25^{\circ} C.)$

8

symbol	parameter	min.	max.	test conditions	unit
tcyc	Enable (E) cycle time	1000			
t _{EWL}	Enable (E) LOW width	450			7
t _{EWH}	Enable (E) HIGH width	450			7
t _R	Enable (R) rise time		20		7
t _F	Enable (F) fall time		20		7
t _{AS1}	READ set-up time	140			ns
t _{AH1}	READ hold time	20			7
t _{AS2}	C/D, CS1B, CS2B, CS3 set-up time	140			7
t _{AH2}	C/D, CS1B, CS2B, CS3 hold time	10			7
t _{DDR}	Data delay time (on the data bus)	320		The loading on	7
t _{DHR}	Data hold time (on the data bus)	20		the data bus is shown in Fig. 18.	



9. DISPLAY CONTROL INSTRUCTION

The display control instructions the internal state of the NT7107. Instruction is received from MPU to NT7107 for the display control. The following table shows various instructions.

Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Display	L	L	L	L	Н	Н		Н	Н	L/H	Controls the
ON/OFF											display on or off. Internal
											status and display RAM
											data is not affected.
											L: OFF, H: ON
Set Address	L	L	L	Н	Y add	ress (0~	·63)				Sets the Y address
(Y address)											in the Y address counter.
Set Page	L	L	Н	L	Н	Н	Н	Page (0~7)		Sets the X address
(X address)											At the X address counter
Display Start	L	L	Н	Н	Displa	ay start l	line (0~6	53)			Indicates the
line											display data RAM
(Z address)											displayed at the top of the
											screen.
Status Read	L	Н	В	L	О	R	L	L	L	L	Read status
			U		N	E					BUSY L: Ready
			S		/	S					H: In operation
			Y		О	E					On/Off L: display ON
					F	T					H: Display OFF
					F						RESET L: Normal
											H: Reset
Write Display	Н	L	Write 1	Date							Writes data (DB0:7) into
Data											display data RAM . After
											writing instruction, Y
											address is increased by 1
											automatically.
Read Display	Н	Н	Read I	Date							Reads data (DB0:7)
data											From display data RAM to
											the data bus.

9-1. Display On/Off

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
0	0	0	0	1	1	1	1	1	D0	

The display data appears when D is 1 and disappears when D is 0.

Though the data is not on the screen with D=0, it remains display data RAM.

Therefore, you can make it appear by changing D=0 into D=1.

9-2. Set Address (Y Address)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0

Y address (AC0~AC5) of the display data RAM is set in the Y address counter.

An address is set by instruction and increased by 1 automatically by read or write operations of display data.

9-3. Set Page (X Address)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	0	1	1	1	AC2	AC1	AC0

X address (AC0~AC2) of the display data RAM is set in the X address register.

Writing or reading to or from MPU is executed in this specified page until the next page is set.

9-4. Display Start Line (Z Address)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	1	AC5	AC4	AC3	AC2	AC1	AC0

Z address (AC0~AC5) of the display data RAM is set in the display start line register and display at the top of the screen. When the display duty cycle is 1/64 or others (1/32~1/64), the data of total line number of LCD screen, from the line specified by display start line instruction, is displayed.

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Product Specification

0-5 Status Road

<i>J</i> -3.	Status IXC	ıu								
RS	\mathbf{R}/\mathbf{W}	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
0	0	BUSY	0	ON/OFF	RESET	0	0	0	0	

■ BUSY

When BUSY is 1, the Chip is executing internal operation and no instructions are accepted.

When BUSY is 0, the Chip is ready to accept any instructions.

ON/OFF

When ON/OFF is 1, the display is on.

When ON/OFF is 0, the display is off.

■ RESET

When RESET is 1, the system is being initialized.

In this condition is 0, no instructions except status read can be accepted.

When RESET is 0, initialized has finished and the system is in the usual operation condition

9-6. Write Display data

R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
1	D7	D6	D5	D4	D3	D2	D1	D0	

Writes data (D0~D7) into the display data RAM.

After writing instruction, Y addressed is increased 1 automatically.

9-7. Read Display data

R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	D7	D6	D5	D4	D3	D2	D1	D0

Reads data (D0~D7) from the display data RAM.

After reading instruction, Y addressed is increased 1 automatically.

10. ELECTRONIC-OPTICAL CHARACTERISTICS

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REF.
Rise Time	Tr	0℃		450	560	**** G	
Kise Time	11	25℃		140	210	ms	Note(1)
Fall Time	Tf	0℃		680	800	****	
	11	25℃		220	330	ms	
Contrast	CR	25℃		2.7			Note(3)
	θ 1			60			
View Angle	θ 2	25℃ &		30			Note(2)
View Angle	Ф1	CR≥2		30			Note(2)
	Ф2		1	30	-		
Frame Frequency	Ff	25℃		64		Hz	

Note (1) & (2): See next page

Note (3): Contrast ratio is defined under the following condition: CR=

Brightness of no-selected condition

(a). Temperature -----25°C

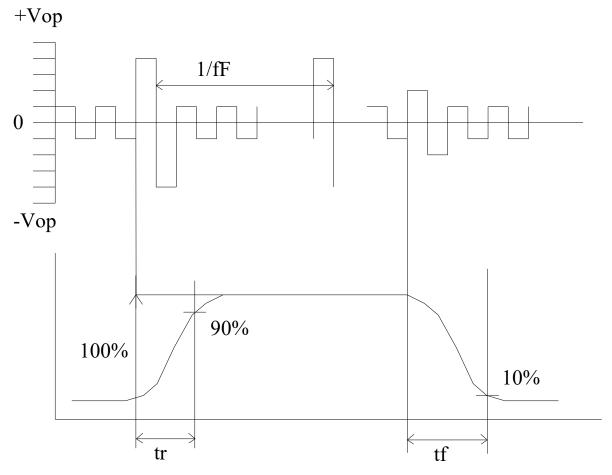
(b). Frame frequency ----64Hz

Brightness of selected condition

(c). viewing angle ----- $\theta = 0^{\circ}$, $\Phi = 0^{\circ}$

(d). Operating voltage-----12V

Note (1) Response time is measured as the shortest period of time possible Between the changes is state of an LCD segment as demonstrated below: entire range.

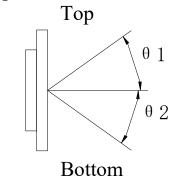


Condition:

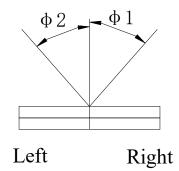
- (a) .Temperature-----25°C
- (b).Frame frequency-----64Hz
- (c). View Angle----- $\theta = 0^{\circ}$, $\phi = 0^{\circ}$
- (d). Operating voltage-----12V

Note(2) definition of View Angle

Top --bottom direction



Right --left direction



11. MODULE ACCEPT QUALITY LEVEL (AQL)

11.1 AQL Standard Value: Critical Defect =0.1, Major Defect=0.65; Minor Defect =2.5

11.2 Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II

12. RELIABILITY TEST

Operating life time: Longer than 75,000 hours

(at room temperature without direct irradiation of sunlight; -20 °C(longer than 35, 000 hours); +70

°C(longer than 35,000hours))

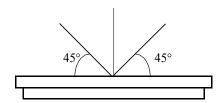
Reliability characteristics shall meet following requirements.

No.	Test Item	Content of Test	Test Condition		
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	+80°C 96H		
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	−30°C 96H		
3	High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the thermal stress to the element for a long time	+70°C 96H		
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time	−20°C 96H		
5	High Temperature/ Humidity Storage	Endurance test applying the high temperature and humidity storage for a long time	50°C 90%RH 96H		
6	Temperature Cycle	Endurance test applying the low and high temperature cycle $-20^{\circ}\text{C} \longleftrightarrow 25^{\circ}\text{C} \longleftrightarrow 70^{\circ}\text{C} \longleftrightarrow 25^{\circ}\text{C}$ $30\text{min} 5\text{min} 30\text{min} 5\text{min}$ 1 cycle	-20°C/70°C 5 cycles		
7	Vibration Test (Package State)	Endurance test applying the vibration during transportation	10Hz - 55Hz, 50m/s,15min		
8	Shock Test (Package State)	Endurance test applying the shock during transportation	Half-sinewave, 100m/s, 11ms		
9	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	40 kPa 16 H		

13. Inspection specification

13.1 Visual Inspection

- 1) Inspect under 2x20W or 40W fluorescent lamp (approximately 3000 lux) leaving 25 to 30 cm between the module and the lamp and 30 cm between the module and the eye (measuring position).
- 2) Appearance is inspected at the best contrast voltage (best contrast is adjusted considering clearness and crosstalk on screen).
- 3) Inspect the module at 45° right and left, top and bottom.
- 4) Use the optimum viewing angle during the contrast inspection.



13.2 Standard of Appearance Inspection

No.	Item		Crite	eria	
		* * *	per following drawin	g	
		$\Phi = (X+Y)/2$	A	cceptable quantity	
	'/////		Size	Zone A	Zone B
			Ф<0.1	Any number	
	<i>"/////</i>	X	0.1<Ф<0.2	2	Any number
			0.2<Ф<0.25	1	Any number
			0.25< Ф	0	
		Line type: as pe	r following drawing Accepta	ble quantity	
	Black spot	Length	Width	Zone A	Zone B
1	White spot	_	W≤0.02	Any num ber	Any
	Dust	L≤3.0	0.02 <w≤0.03< td=""><td>2</td><td>nu mb</td></w≤0.03<>	2	nu mb
		L≤2.5	0.03 <w≤0.05< td=""><td></td><td>er</td></w≤0.05<>		er
		_	0.05 <w< td=""><td>As round type</td><td></td></w<>	As round type	
		L Total acceptable	•		
2	Polariser		ective film is permitte	ed	
	scratch		riser: same as No. 1		
3	Polariser bubble	$\Phi = (X+Y)/2$			

			Acceptable quant			
	/////X	Size	Zone A	Zone B		
	X	Ф<0.2	Any nu m be			
	Total acceptable quantity: 3	0.2<Ф	r	Any nu		
		<0. 5 0.5< Φ	2	ml er		
		<1. 0				
		1.0<Ф	0			
	4.1 Pin hole on segment	ed display				
	W: segment width					
	$\Phi = (A+B)/2$	A	acceptable quantity			
		Width	Quar			
		W≤0.4	Φ≤0.2	and Φ ≤1/2W		
		W>0.4	$\Phi \le 0.25$ ar $\Phi \le 1/3W$			
	4.2 Pin hole on dot matrix display	segment	ole quantity: 1 defe vith Ф under 0.1 le	_		
	W		Acceptable	auantity		
Segment	_₩ _≤0.0	5	Size	quantity		
4 deform ation	\[\]	<u></u>	a, b<0.1	Any n n b		
	Total acceptable quantit	v: 7		1		
	4.3 Segments / dots with width		(a+b)/2≤0.1	Any n n b		
		_	0.5<Ф <1.0	3		
			Acceptable			
	A B		a≥b a/	b≤4/3 b>4/3		

L _{GD17}		_						
		- B\\ B	X 7/A					
						ible quan	itity	
					Size			
							Any	
		<u> </u>		7			nu	
		'			Φ≤0.4		m	
		\		2 /			be	
		≥ <u>. </u>		`			r	
					0.4< Φ			
					≤1.		5	
					0			
		Total acc	ceptable quan	tity: 7	1.0< Ф			
					≤1.		3	
					5			
					1.5< Ф			
					≤ 2.		2	
	Colour			<u> </u>				
5	unifor	Level of	sample for an	proval set as l	imit sample			
	mity				· · · · · · · · · · · · · · ·			
		The back	dight colour s	should correspond	ond to the pr	oduct spe	ecificati	on
6	Backlight			acklight is not		_		
		Dust larg	ger than 0.25 i	mm is not allo	wed			
		Exposed	wire bond pa	d is not allowed	ed			
7	COB	Insuffici	ent covering v	with resin is no	not allowed (wire bond line			
				bubble on the				
				aste should be				
				ssing solder co	nnections, or	r oxidatio	on are no	ot
8	PCB		wed					
				alls on PCB a				
		Short cir	cuits on comp	onents are not	allowed			
				Acceptable	quantity			
				Size	Q	uantity		
			On			Any		
			t	Ф<0.	2	nu		
			r	\$ \0.	.2	mb		
			a			er		
	Tray		У	$\Phi > 0.2$	25	4		
9	particle		On	Φ ≥0	.25	2		
	S		d					
			i					
			s					
			p	L=3		1		
			1					
			a					
			у					

14. LCD MODULES HANDLING PRECAUTIONS

- Please remove the protection foil of polarizer before using.
- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - -Be sure to ground the body when handling the LCD module.
 - -Tools required for assembly, such as soldering irons, must be properly grounded.
 - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- Storage precautions
 - When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0 °C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

15. OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
 - Exposed area of the printed circuit board
 - Terminal electrode sections